FCH070N60E Datasheet

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DiGi Electronics Part Number	FCH070N60E-DG
Manufacturer	onsemi
Manufacturer Product Number	FCH070N60E
Description	MOSFET N-CH 600V 52A TO247
Detailed Description	N-Channel 600 V 52A (Tc) 481W (Tc) Through Hole TO-247-3

Purchase and inquiry

Manufacturer Product Number:	FCH070N60E	Manufacturer:	onsemi
Series:	SuperFET® II	Product Status:	Not For New Designs
FET Type:	N-Channel	Technology:	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	600 V	Current - Continuous Drain (Id) @ 25°C:	52A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	10V	Rds On (Max) @ Id, Vgs:	70mOhm @ 26A, 10V
Vgs(th) (Max) @ Id:	3.5V @ 250μA	Gate Charge (Qg) (Max) @ Vgs:	166 nC @ 10 V
Vgs (Max):	±20V	Input Capacitance (Ciss) (Max) @ Vds:	4925 pF @ 380 V
FET Feature:	-	Power Dissipation (Max):	481W (Tc)
Operating Temperature:	-55°C ~ 150°C (TJ)	Mounting Type:	Through Hole
Supplier Device Package:	TO-247-3	Package / Case:	TO-247-3
Base Product Number:	FCH070		

Environmental & Export classification

RoHS Status:	ROHS3 Compliant	Moisture Sensitivity Level (MSL):	Not Applicable
REACH Status:	REACH Unaffected	ECCN:	EAR99
HTSUS:	8541.29.0095		

MOSFET – N-Channel, SUPERFET® II, Easy-Drive

600 V, 52 A, 70 mΩ

FCH070N60E

V_{DS}	$R_{DS(ON)}$ MAX	I_D MAX
600 V	70 mΩ @ 10 V	52 A

Description

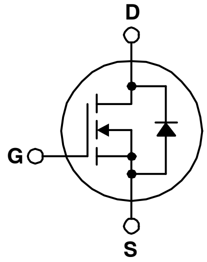
SUPERFET II MOSFET is **onsemi**'s brand−new high voltage super−junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on−resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET easy−drive series offers slightly slower rise and fall times compared to the SUPERFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the SUPERFET II MOSFET series.

Features

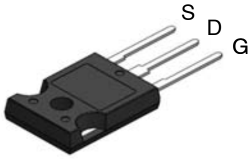
- Typ. $R_{DS(on)}$ = 58 mΩ
- 650 V @ T_J = 150°C
- Ultra Low Gate Charge (Typ. Q_g = 128 nC)
- Low Effective Output Capacitance (Typ. $C_{oss(eff.)}$ = 457 pF)
- 100% Avalanche Tested
- These Devices are Pb−Free and are RoHS Compliant

Applications

- Telecom / Sever Power Supplies
- Industrial Power Supplies

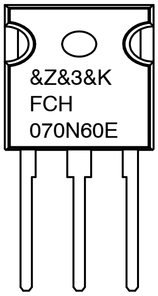


N-CHANNEL MOSFET



TO−247−3LD
CASE 340CK

MARKING DIAGRAM



&Z = Assembly Plant Code
&3 = Numeric Date Code
&K = Lot Code
FCH070N60E = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

August, 2024 − Rev. 3

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol	Parameter		FCH070N60E	Unit
V_{DSS}	Drain to Source Voltage		600	V
V_{GSS}	Gate to Source Voltage	– DC	±20	V
		– AC (f > 1 Hz)	±30	
I_D	Drain Current:	– Continuous (T_C = 25°C)	52	A
		– Continuous (T_C = 100°C)	33	
I_{DM}	Drain Current:	– Pulsed (Note 1)	156	A
E_{AS}	Single Pulsed Avalanche Energy (Note 2)		1128	mJ
I_{AR}	Avalanche Current (Note 1)		9.5	A
E_{AR}	Repetitive Avalanche Energy (Note 1)		4.8	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		20	
P_D	Power Dissipation	(T_C = 25°C)	481	W
		– Derate Above 25°C	3.85	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		–55 to + 150	°C
T_L	Maximum Lead Temperature for Soldering, 1/8″ from Case for 5 seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse–width limited by maximum junction temperature.
2. I_{AS} = 9.5 A, R_G = 25 Ω, Starting T_J = 25 °C.
3. $I_{SD} \le 26$ A, di/dt ≤ 200 A/μs, $V_{DD} \le 380$ V, Starting T_J = 25 °C.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH070N60E	FCH070N60E	TO–247	Tube	N/A	N/A	30 Units

THERMAL CHARACTERISTICS

Symbol	Parameter	FCH070N60E	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.26	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 10 mA, V_{GS} = 0 V, T_J = 25°C	600	–	–	V
		I_D = 10 mA, V_{GS} = 0 V, T_J = 150°C	650	–	–	
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	I_D = 10 mA, Referenced to 25°C	–	0.7	–	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 600 V, V_{GS} = 0 V	–	–	1	μA
		V_{DS} = 480 V, V_{GS} = 0 V, T_C = 125 °C	–	3.4	–	
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	–	–	±100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250 μA	2.5	–	3.5	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 26 A	–	58	70	mΩ
g_{FS}	Forward Transconductance	V_{DS} = 20 V, I_D = 26 A	–	44	–	S
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	V_{DS} = 380 V, V_{GS} = 0 V, f = 1 MHz	–	3705	4925	pF
C_{oss}	Output Capacitance		–	116	155	pF
C_{rss}	Reverse Transfer Capacitance		–	12.3	20	pF
$C_{oss(eff.)}$	Effective Output Capacitance	V_{DS} = 0 V to 480 V, V_{GS} = 0 V	–	457	–	pF
$Q_{g(tot)}$	Total Gate Charge at 10 V	V_{DS} = 380 V, I_D = 26 A, V_{GS} = 10 V (Note 4)	–	128	166	nC
Q_{gs}	Gate to Source Gate Charge		–	18	–	nC
Q_{gd}	Gate to Drain “Miller” Charge		–	54	–	nC
ESR	Equivalent Series Resistance	f = 1 MHz	–	0.6	–	Ω
SWITCHING CHARACTERISTICS						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 380 V, I_D = 26 A, V_{GS} = 10 V, R_g = 4.7 Ω (Note 4)	–	29	68	ns
t_r	Turn–On Rise Time		–	28	66	ns
$t_{d(off)}$	Turn-Off Delay Time		–	122	254	ns
t_f	Turn–Off Fall Time		–	28	66	ns
DRAIN-SOURCE DIODE CHARACTERISTICS						
I_S	Maximum Continuous Source to Drain Diode Forward Current		–	–	52	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		–	–	156	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0 V, I_{SD} = 26 A	–	–	1.2	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 26 A, dI_F/dt = 100 A/μs	–	463	–	ns
Q_{rr}	Reverse Recovery Charge		–	10.4	–	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS

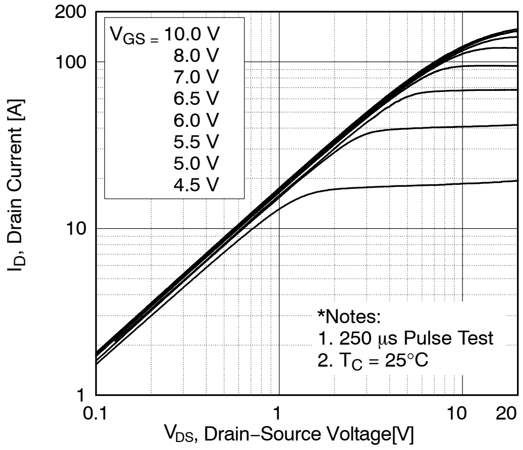


Figure 1. On−Region Characteristics

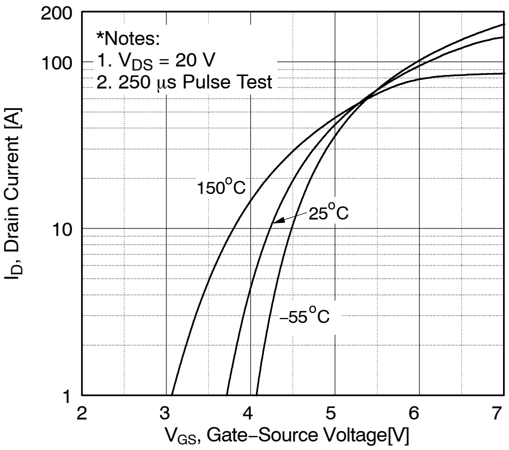


Figure 2. Transfer Characteristics

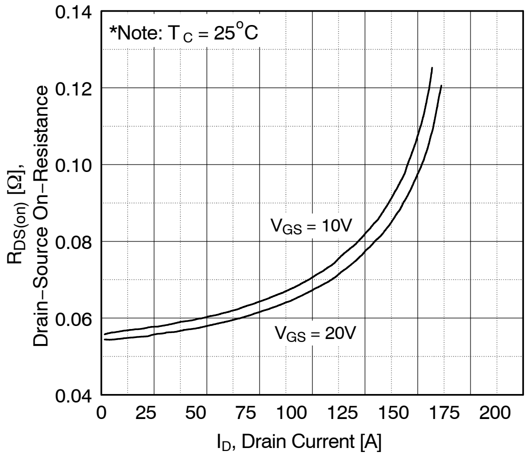


Figure 3. On−Resistance Variation vs. Drain Current and Gate Voltage

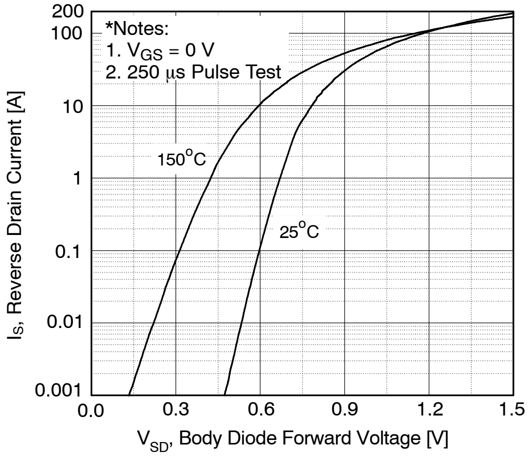


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

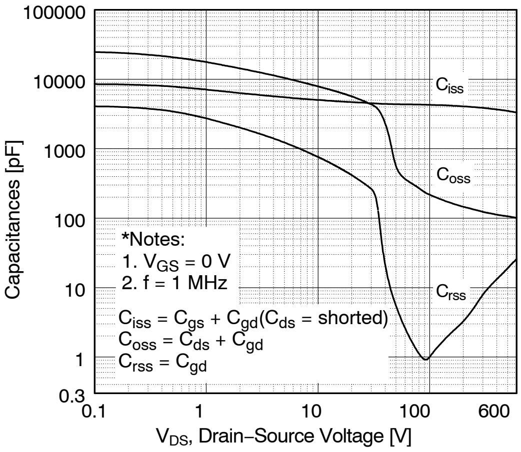


Figure 5. Capacitance Characteristics

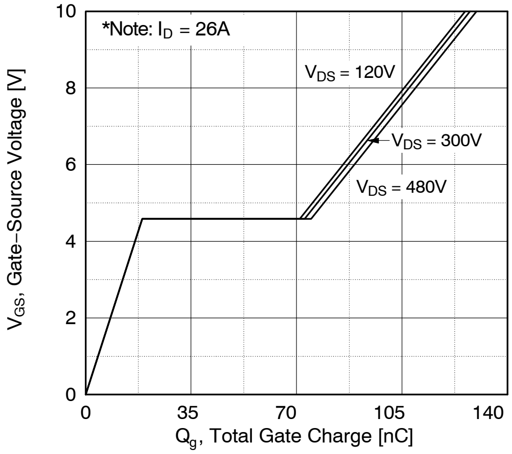


Figure 6. Gate Charge Characteristics

TYPICAL CHARACTERISTICS

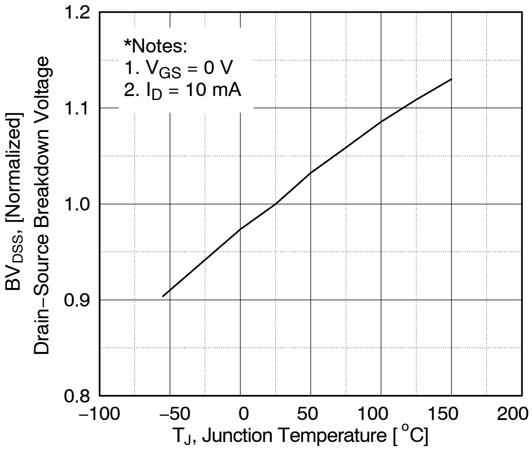


Figure 7. Breakdown Voltage Variation vs. Temperature

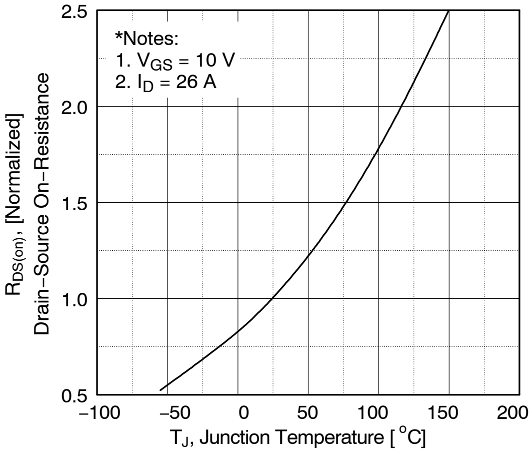


Figure 8. On−Resistance Variation vs. Temperature

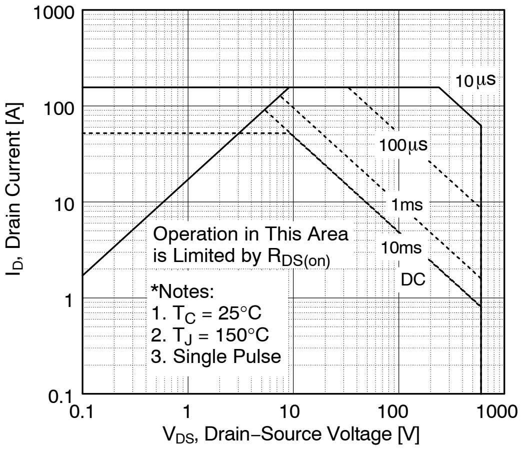


Figure 9. Maximum Safe Operating Area

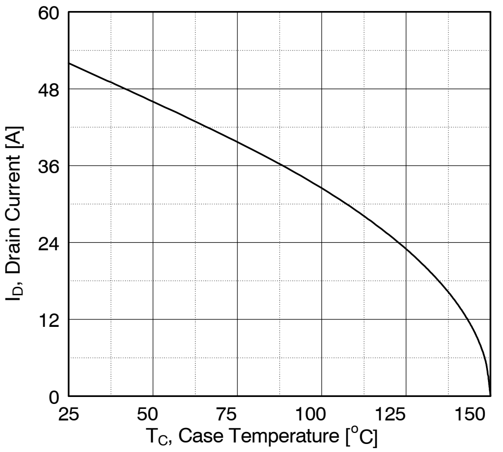


Figure 10. Maximum Drain Current vs. Case Temperature

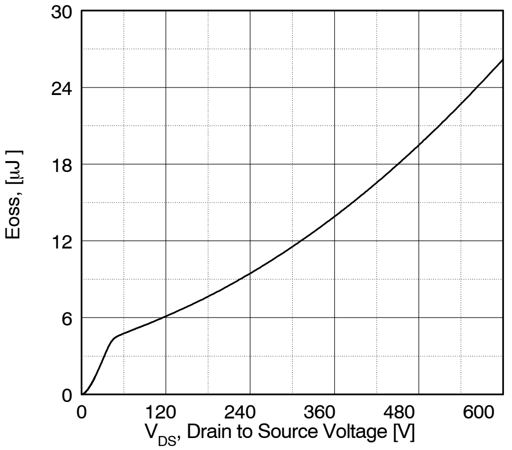


Figure 11. Eoss vs. Drain to Source Voltage

TYPICAL CHARACTERISTICS

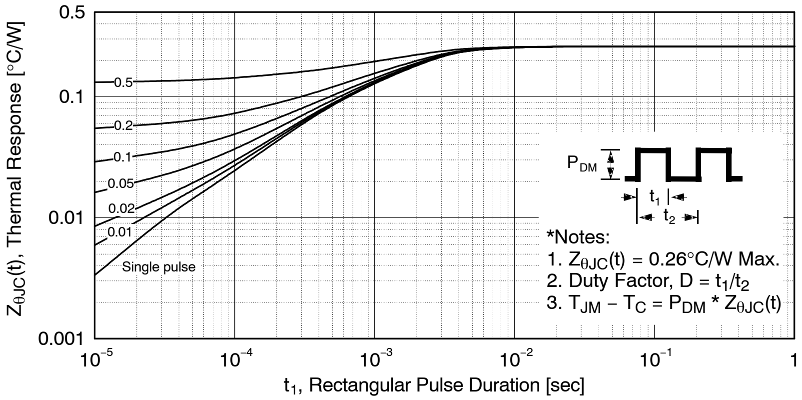


Figure 12. Transient Thermal Response Curve

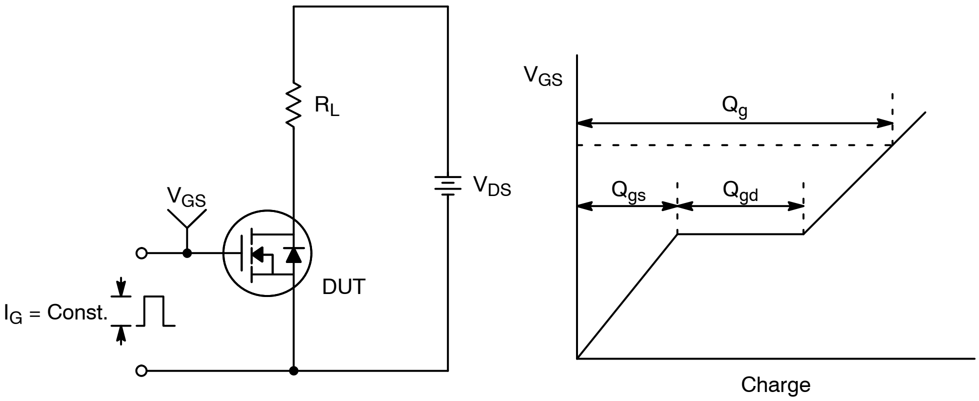


Figure 13. Gate Charge Test Circuit & Waveform

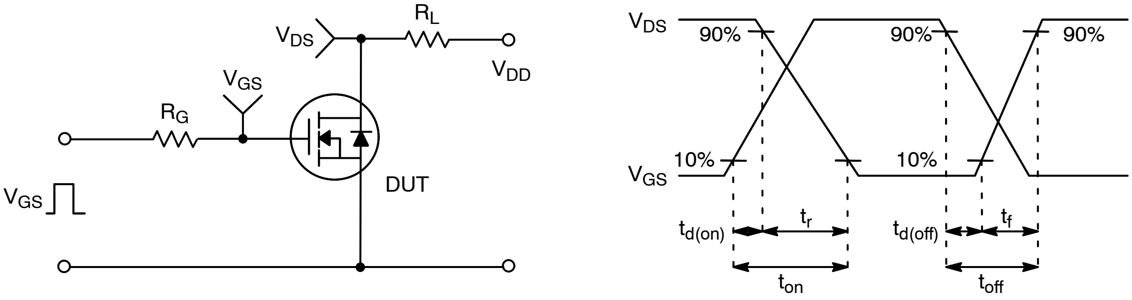


Figure 14. Resistive Switching Test Circuit & Waveforms

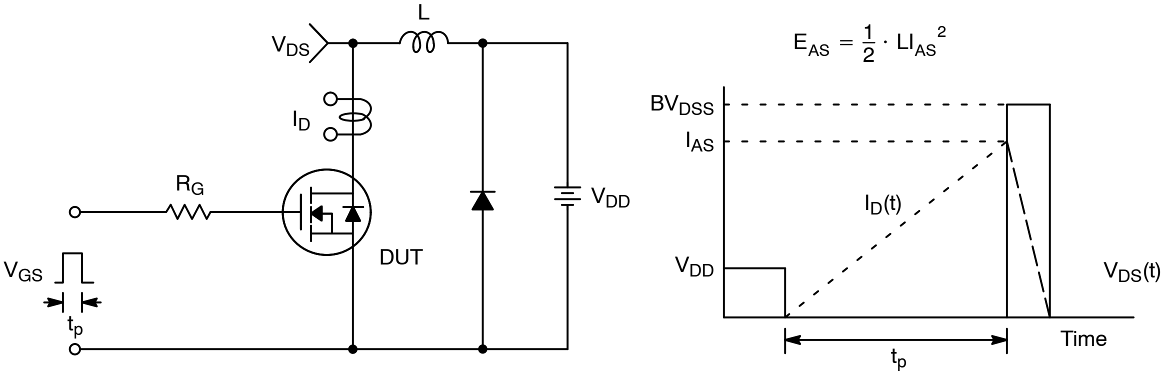


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

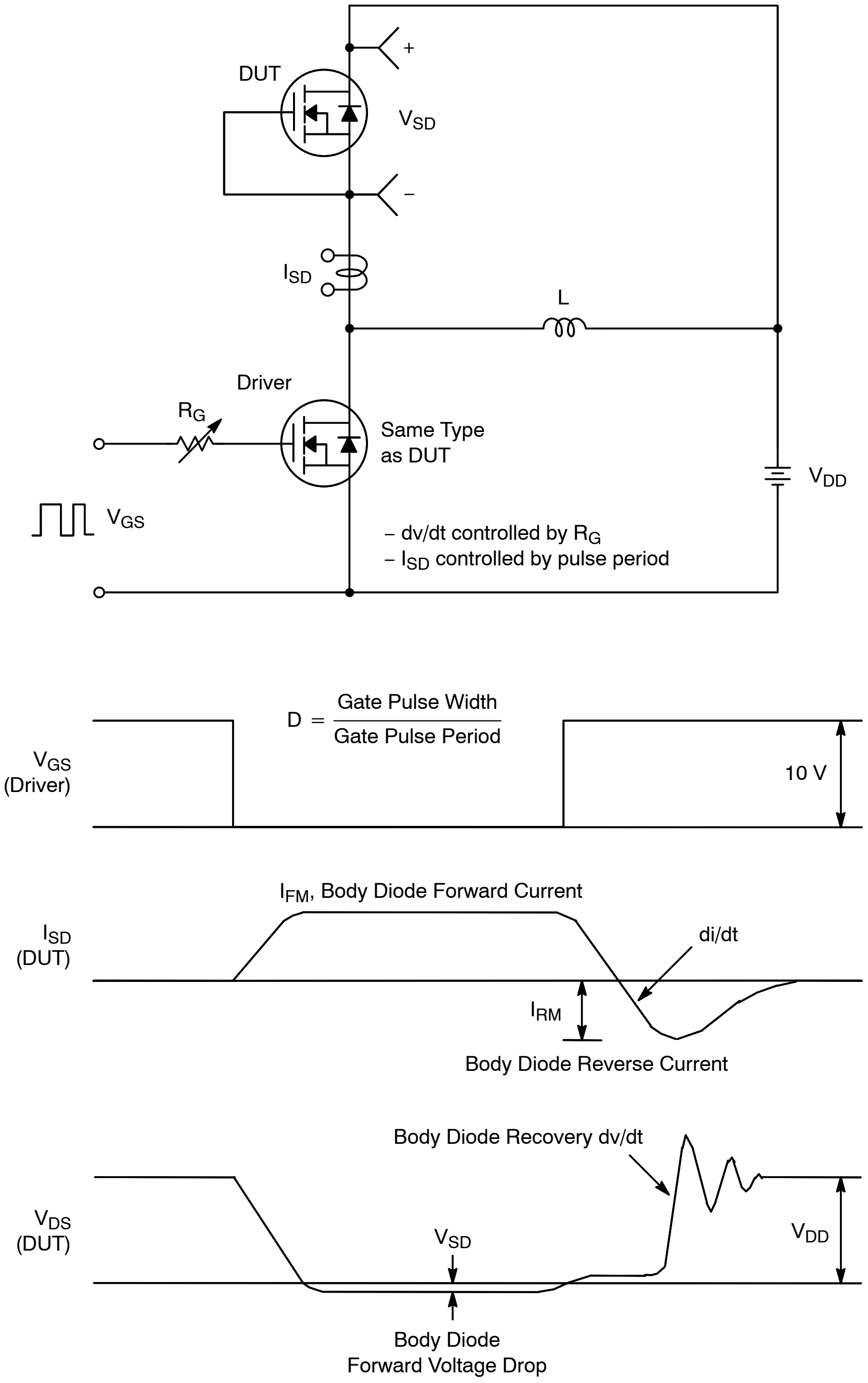


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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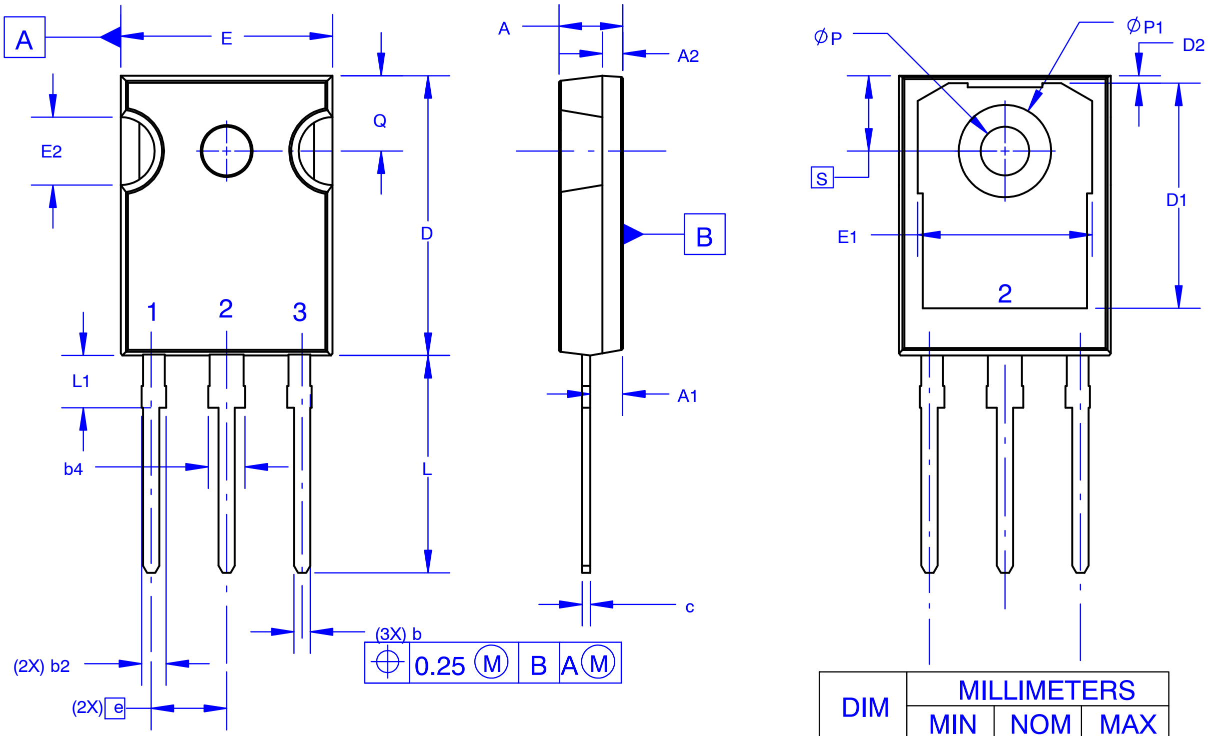
MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

TO−247−3LD SHORT LEAD
CASE 340CK
ISSUE A

DATE 31 JAN 2019



DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.20	2.40	2.60
A2	1.40	1.50	1.60
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
c	0.51	0.61	0.71
D	20.32	20.57	20.82
D1	13.08	~	~
D2	0.51	0.93	1.35
E	15.37	15.62	15.87
E1	12.81	~	~
E2	4.96	5.08	5.20
e	~	5.56	~
L	15.75	16.00	16.25
L1	3.69	3.81	3.93
ØP	3.51	3.58	3.65
ØP1	6.60	6.80	7.00
Q	5.34	5.46	5.58
S	5.34	5.46	5.58

NOTES: UNLESS OTHERWISE SPECIFIED.

A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*

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AYWWZZ
XXXXXXX
XXXXXXX
o
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XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	**TO−247−3LD SHORT LEAD**	**PAGE 1 OF 1**

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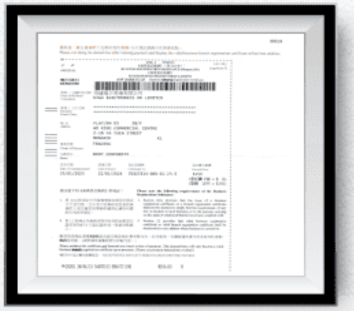

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